

# SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

# ATP602 — General-Purpose Switching Device Applications

# **Features**

- ON-resistance RDS(on)= $2.1\Omega$  (typ.)
- · 10V drive

- Input capacitance Ciss=350pF (typ.)
- · Halogen free compliance

# **Specifications**

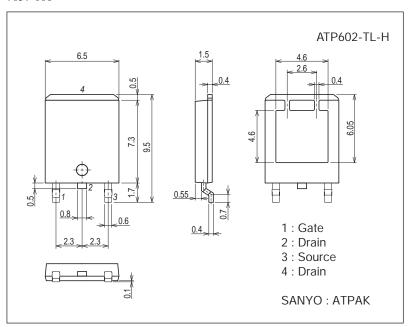
# Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>		600	V
Gate-to-Source Voltage	V <sub>GSS</sub>		±30	V
Drain Current (DC)	ID		5	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	15	Α
Allowable Power Dissipation	PD	Tc=25°C	70	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		74	mJ
Avalanche Current *2	IAV		5	А

Note: \*1 VDD=99V, L=5mH, IAV=5A (Fig.1)

## **Package Dimensions**

unit : mm (typ) 7057-001



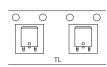
# **Product & Package Information**

• Package : ATPAK

• JEITA, JEDEC :-

• Minimum Packing Quantity : 3,000 pcs./reel

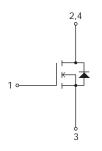
# Packing Type: TL



# Marking



#### **Electrical Connection**



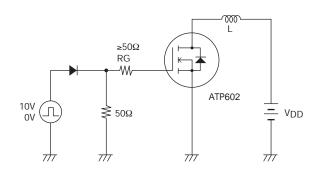
<sup>\*2</sup> L≤5mH, Single pulse

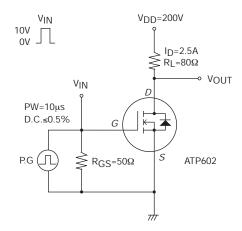
## Electrical Characteristics at Ta=25°C

Parameter	Cumbal	Conditions	Ratings			Unit
Parameter	Symbol	Conditions	min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=10mA, VGS=0V	600			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =480V, V <sub>GS</sub> =0V			100	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V			±100	nA
Cutoff Voltage	V <sub>GS</sub> (off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	3		5	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =2.5A	1.5	2.9		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =2.5A, V <sub>GS</sub> =10V		2.1	2.7	Ω
Input Capacitance	Ciss			350		pF
Output Capacitance	Coss	V <sub>DS</sub> =30V, f=1MHz		68		pF
Reverse Transfer Capacitance	Crss			15		pF
Turn-ON Delay Time	t <sub>d</sub> (on)			14.2		ns
Rise Time	t <sub>r</sub>	Car Fig 2		37.4		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See Fig.2		36.2		ns
Fall Time	tf			20.4		ns
Total Gate Charge	Qg			13.6		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =5A		3.4		nC
Gate-to-Drain "Miller" Charge	Qgd			7.2		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =5A, V <sub>GS</sub> =0V		0.9	1.2	V

Fig.1 Avalanche Resistance Test Circuit

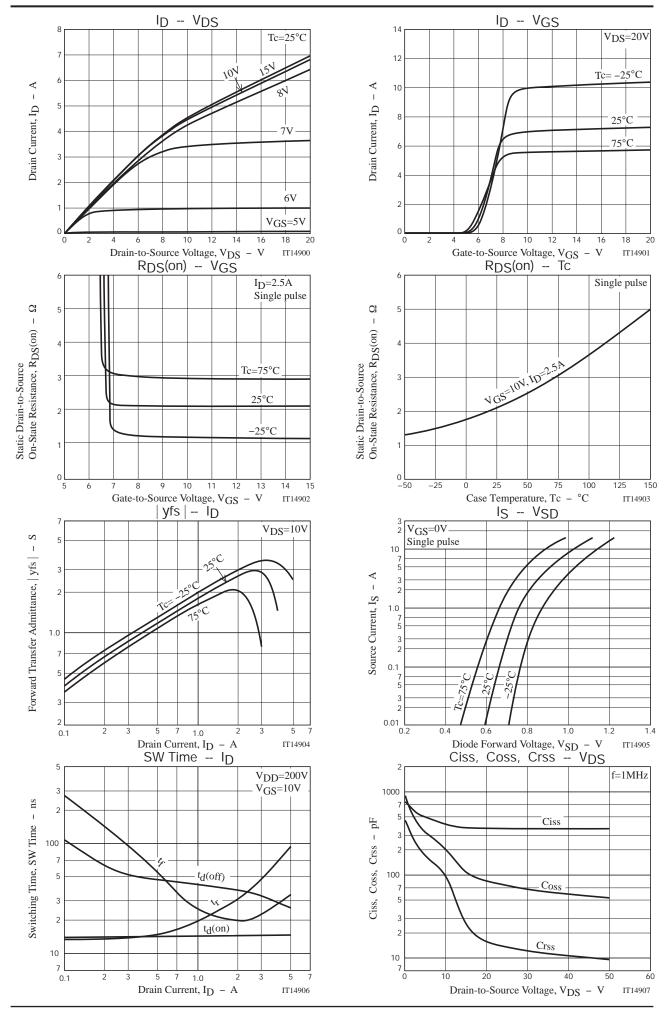
Fig.2 Switching Time Test Circuit

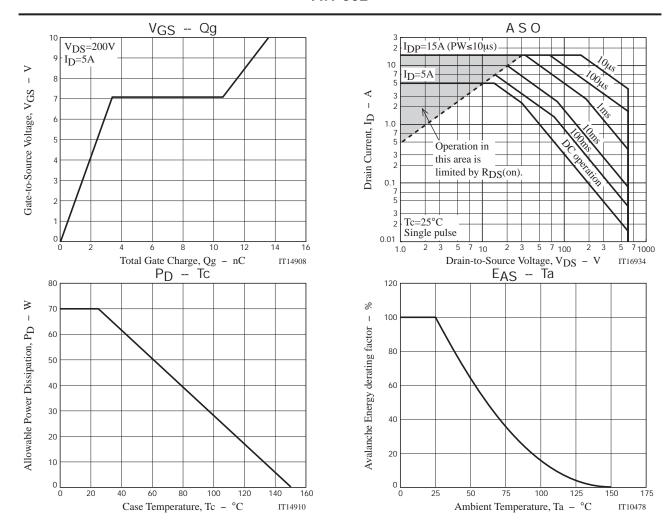




# **Ordering Information**

Device	Package	Shipping	memo
ATP602-TL-H	ATPAK	3,000pcs./reel	Pb Free and Halogen Free



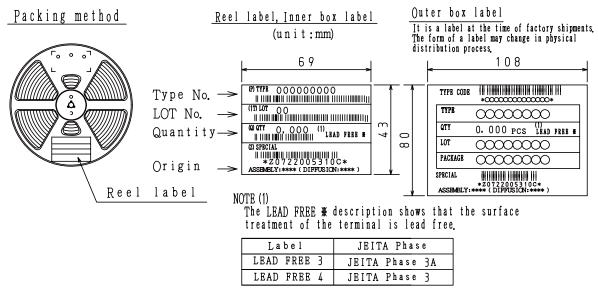


#### **Taping Specification**

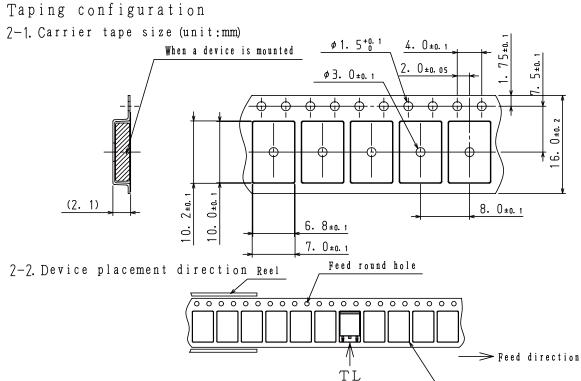
ATP602-TL-H

# 1. Packing Format (TL)

Package Name Carrier Tape		Maximum Number of devices contained (pcs)			Packing format		
rackage Name	Туре	Reel	Inner box	Outer box	INNER BOX SD-C-18	OUTER BOX SD-A-18	
					1 reels contained	5 inner boxes contained	
ATPAK	ATP	3,000	3,000	15,000	Dimensions:mm (external)	Dimensions:mm (external)	
					340×340×28	355×355×165	



# 7. Taping configuration

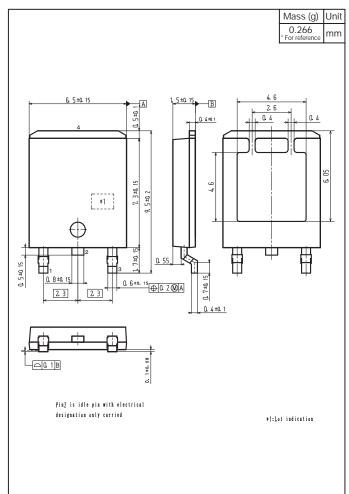


The one erectrode terminals on feed hole side····TL

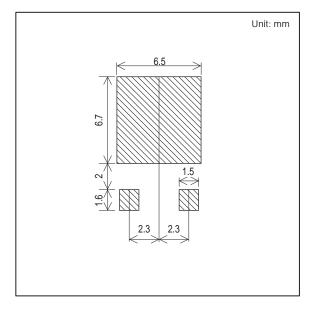
Carrier tape

# **Outline Drawing**

ATP602-TL-H



# **Land Pattern Example**



Note on usage: Since the ATP602 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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